

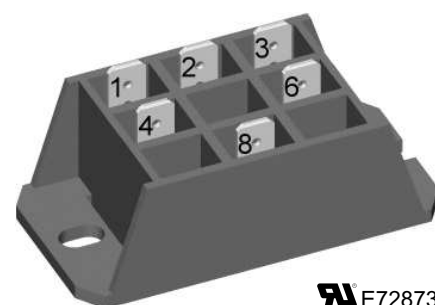
# Half Controlled Single Phase Rectifier Bridge with Freewheeling Diode

$$I_{dAVM} = 32 \text{ A}$$

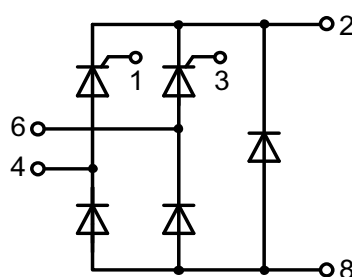
$$V_{RRM} = 800-1600 \text{ V}$$

## Part numbers

| $V_{RSM}$<br>$V_{DSM}$<br>V | $V_{RRM}$<br>$V_{DRM}$<br>V | Type         |
|-----------------------------|-----------------------------|--------------|
| 900                         | 800                         | VHF 28-08io5 |
| 1300                        | 1200                        | VHF 28-12io5 |
| 1700                        | 1600                        | VHF 28-16io5 |



**RL** E72873



## Features / Advantages:

- Planar passivated chips
- Space and weight savings
- Improved temperature & power cycling

## Applications:

- Supply for DC power equipment
- DC motor control

## Package: FO-F

- Isolation Voltage: 3600 V~
- DCB ceramic base plate
- 1/4" fast-on terminals
- Easy to mount with two screws
- RoHS compliant

## Disclaimer Notice

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| Diodes               |                                     |                                                                                                                                                                                                                                          |                              | Ratings |      |              |                                      |
|----------------------|-------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------|---------|------|--------------|--------------------------------------|
| Symbol               | Definitions                         | Conditions                                                                                                                                                                                                                               |                              | min.    | typ. | max.         | Unit                                 |
| $I_{dAV}$            | average DC output current           | module                                                                                                                                                                                                                                   | $T_K = 85^\circ\text{C}$     |         |      | 28           | A                                    |
| $I_{dAVM}$           | max. average DC output current      | for resistive load                                                                                                                                                                                                                       |                              |         |      | 32           | A                                    |
| $I_{FRMS}, I_{TRMS}$ | RMS forward current                 | per leg                                                                                                                                                                                                                                  |                              |         |      | 23           | A                                    |
| $I_{FSM}, I_{TSM}$   | max. surge forward current          | $t = 10\text{ ms (50 Hz), sine}$                                                                                                                                                                                                         | $T_{VJ} = 45^\circ\text{C}$  |         |      | 300          | A                                    |
|                      |                                     | $t = 8.3\text{ ms (60 Hz), sine; } V_R = 0\text{ V}$                                                                                                                                                                                     |                              |         |      | 330          | A                                    |
|                      |                                     | $t = 10\text{ ms (50 Hz), sine}$                                                                                                                                                                                                         | $T_{VJ} = 125^\circ\text{C}$ |         |      | 270          | A                                    |
|                      |                                     | $t = 8.3\text{ ms (60 Hz), sine; } V_R = 0\text{ V}$                                                                                                                                                                                     |                              |         |      | 300          | A                                    |
| $I^2t$               | $I^2t$ value for fusing             | $t = 10\text{ ms (50 Hz), sine}$                                                                                                                                                                                                         | $T_{VJ} = 45^\circ\text{C}$  |         |      | 440          | A <sup>2</sup> s                     |
|                      |                                     | $t = 8.3\text{ ms (60 Hz), sine; } V_R = 0\text{ V}$                                                                                                                                                                                     |                              |         |      | 455          | A <sup>2</sup> s                     |
|                      |                                     | $t = 10\text{ ms (50 Hz), sine}$                                                                                                                                                                                                         | $T_{VJ} = 125^\circ\text{C}$ |         |      | 365          | A <sup>2</sup> s                     |
|                      |                                     | $t = 8.3\text{ ms (60 Hz), sine; } V_R = 0\text{ V}$                                                                                                                                                                                     |                              |         |      | 370          | A <sup>2</sup> s                     |
| $(di/dt)_{cr}$       | critical rate of rise of current    | $f = 50\text{ Hz, } t_p = 200\text{ }\mu\text{s, } V_D = 2/3 V_{DRM}, T_{VJ} = 125^\circ\text{C}$<br>$I_G = 0.3\text{ A, } di_G/dt = 0.3\text{ A}/\mu\text{s}$<br>repetitive, $I_T = 50\text{ A}$<br>non repetitive, $I_T = 1/2 I_{dAV}$ |                              |         |      | 150<br>500   | A/ $\mu\text{s}$<br>A/ $\mu\text{s}$ |
| $(dv/dt)_{cr}$       | critical rate of rise of voltage    | $V_D = 2/3 V_{DRM}, T_{VJ} = 125^\circ\text{C}$<br>$R_{GK} = \infty$ ; method 1 (linear voltage rise)                                                                                                                                    |                              |         |      | 1000         | V/ $\mu\text{s}$                     |
| $V_{RGM}$            | max. reverse gate voltage           |                                                                                                                                                                                                                                          |                              |         |      | 10           | V                                    |
| $P_{GM}$             | max. gate power dissipation         | $I_T = I_{TAVM}$<br>$t_p = 30\text{ }\mu\text{s}$<br>$t_p = 500\text{ }\mu\text{s}$<br>$t_p = 10\text{ ms}$                                                                                                                              | $T_{VJ} = 125^\circ\text{C}$ |         |      | 10<br>5<br>1 | W<br>W<br>W                          |
| $P_{GAVM}$           | max. average gate power dissipation |                                                                                                                                                                                                                                          |                              |         |      | 0.5          | W                                    |

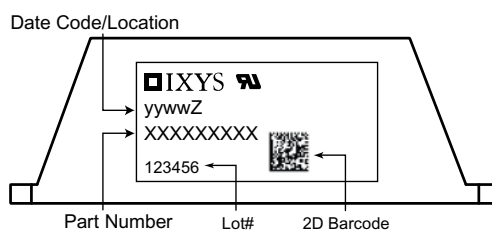
| Thyristors |                                         |                                                                                                      |                                                                                             | Ratings |            |                   |                |
|------------|-----------------------------------------|------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------|---------|------------|-------------------|----------------|
| Symbol     | Definitions                             | Conditions                                                                                           |                                                                                             | min.    | typ.       | max.              | Unit           |
| $I_R, I_D$ | reverse, drain current                  | $V_R = V_{RRM}; V_D = V_{DRM}$                                                                       | $T_{VJ} = 25^\circ\text{C}$<br>$T_{VJ} = 125^\circ\text{C}$                                 |         |            | 0.3<br>5          | mA<br>mA       |
| $V_T, V_F$ | forward voltage                         | $I_T, I_F = 45\text{ A}$                                                                             | $T_{VJ} = 25^\circ\text{C}$                                                                 |         |            | 1.6               | V              |
| $V_{TO}$   |                                         | For power-loss calculations only                                                                     | $T_{VJ} = 125^\circ\text{C}$                                                                |         | 0.9        |                   | V              |
| $r_T$      |                                         |                                                                                                      |                                                                                             |         | 15         |                   | m $\Omega$     |
| $V_{GT}$   | gate trigger voltage                    | $V_D = 6\text{ V}$                                                                                   | $T_{VJ} = 25^\circ\text{C}$<br>$T_{VJ} = -40^\circ\text{C}$                                 |         |            | 1.0<br>1.2        | V<br>V         |
| $I_{GT}$   | gate trigger current                    | $V_D = 6\text{ V}$                                                                                   | $T_{VJ} = 25^\circ\text{C}$<br>$T_{VJ} = -40^\circ\text{C}$<br>$T_{VJ} = 125^\circ\text{C}$ |         |            | 65<br>80<br>50    | mA<br>mA<br>mA |
| $V_{GD}$   | gate non-trigger voltage                | $V_D = 2/3 V_{DRM}$                                                                                  | $T_{VJ} = 125^\circ\text{C}$                                                                |         |            | 0.2               | V              |
| $I_{GD}$   | non-trigger gate current                |                                                                                                      |                                                                                             |         |            | 5                 | mA             |
| $I_L$      | latching current                        | $I_G = 0.3\text{ A, } t_G = 30\text{ }\mu\text{s}$<br>$di_G/dt = 0.3\text{ A}/\mu\text{s}$           | $T_{VJ} = 25^\circ\text{C}$<br>$T_{VJ} = -40^\circ\text{C}$<br>$T_{VJ} = 125^\circ\text{C}$ |         |            | 150<br>200<br>100 | mA<br>mA<br>mA |
| $I_H$      | holding current                         | $V_D = 6\text{ V, } R_{GK} = \infty$                                                                 | $T_{VJ} = 25^\circ\text{C}$                                                                 |         |            | 100               | ns             |
| $t_{gd}$   | gate controlled delay time              | $V_D = 1/2 V_{DRM}$<br>$I_G = 0.3\text{ A, } di_G/dt = 0.3\text{ A}/\mu\text{s}$                     | $T_{VJ} = 25^\circ\text{C}$                                                                 |         | 2          |                   | $\mu\text{s}$  |
| $t_q$      | turn-off time                           | $I_T = 15\text{ A, } t_p = 300\text{ }\mu\text{s, } V_R = 100\text{ V; } T_{VJ} = 125^\circ\text{C}$ |                                                                                             |         | 150        |                   | $\mu\text{s}$  |
| $Q_r$      | reverse recovery charge                 | $di/dt = -10\text{ A}/\mu\text{s, } dv/dt = 20\text{ V}/\mu\text{s, } V_D = 2/3 V_{DRM}$             |                                                                                             |         | 75         |                   | $\mu\text{C}$  |
| $R_{thJC}$ | thermal resistance junction to case     | per thyristor (diode); DC current<br>per module                                                      |                                                                                             |         |            | 1.4<br>0.35       | K/W<br>K/W     |
| $R_{thJH}$ | thermal resistance junction to heatsink | per thyristor (diode); DC current<br>per module                                                      |                                                                                             |         | 2.0<br>0.5 |                   | K/W<br>K/W     |

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.

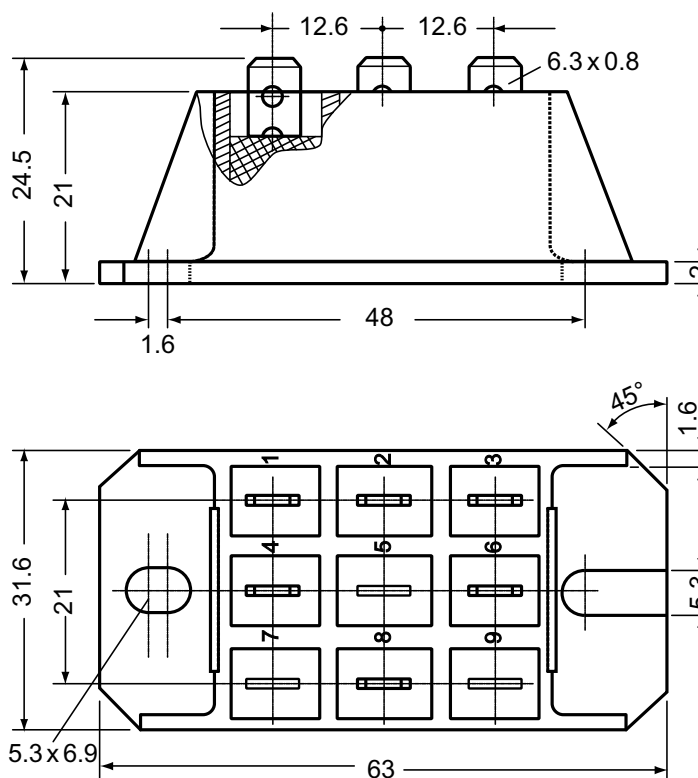
IXYS reserves the right to change limits, test conditions and dimensions.

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| Package FO-F  |                                                              |                      |                                     | Ratings |      |      | Unit |
|---------------|--------------------------------------------------------------|----------------------|-------------------------------------|---------|------|------|------|
| Symbol        | Definitions                                                  | Conditions           |                                     | min.    | typ. | max. |      |
| $I_{RMS}$     | RMS current                                                  | per terminal         |                                     |         |      | 100  | A    |
| $T_{VJ}$      | virtual junction temperature                                 |                      |                                     | -40     |      | 125  | °C   |
| $T_{op}$      | operation temperature                                        |                      |                                     | -40     |      | 100  | °C   |
| $T_{stg}$     | storage temperature                                          |                      |                                     | -40     |      | 125  | °C   |
| <b>Weight</b> |                                                              |                      |                                     |         | 45   |      | g    |
| $M_D$         | mounting torque                                              |                      |                                     | 2       |      | 2.5  | Nm   |
| $d_{Spp/App}$ | creepage distance on surface / striking distance through air | terminal to terminal | 18.0                                | 6.0     |      |      | mm   |
| $d_{Spb/Apb}$ |                                                              | terminal to backside | 26.0                                | 20.0    |      |      | mm   |
| $V_{ISOL}$    | isolation voltage                                            | t = 1 second         | 50/60 Hz, RMS, $I_{ISOL} \leq 1$ mA | 3600    |      |      | V    |
|               |                                                              | t = 1 minute         |                                     | 3000    |      |      | V    |



Dimensions in mm (1 mm = 0.0394")



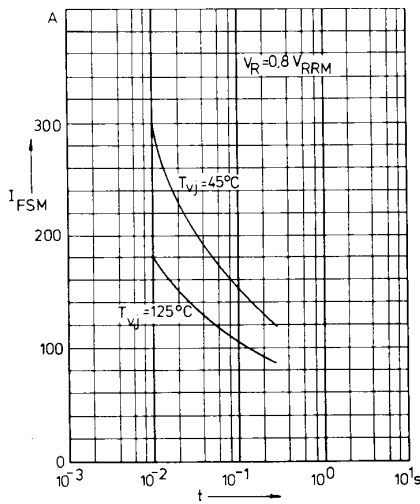


Fig. 1 Surge overload current per chip  
 $I_{FSM}$ : Crest value,  $t$ : duration

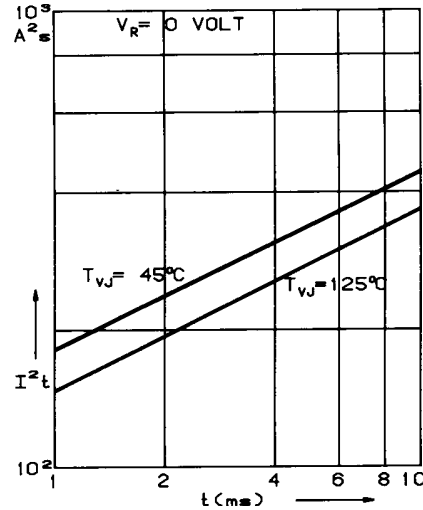


Fig. 2  $I^2t$  versus time (1-10 ms)  
per chip

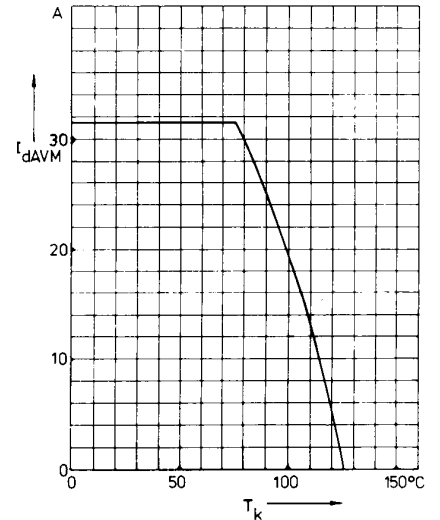


Fig. 3 Max. forward current at  
heatsink temperature

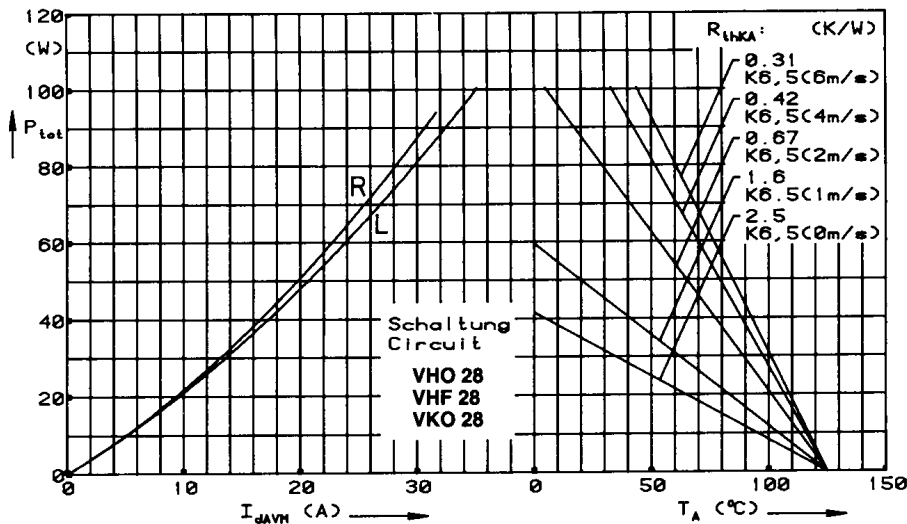


Fig. 4 Power dissipation versus direct output current and ambient temperature

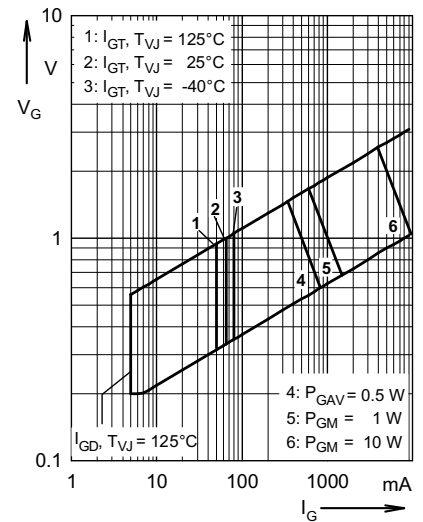


Fig. 5 Gate trigger range

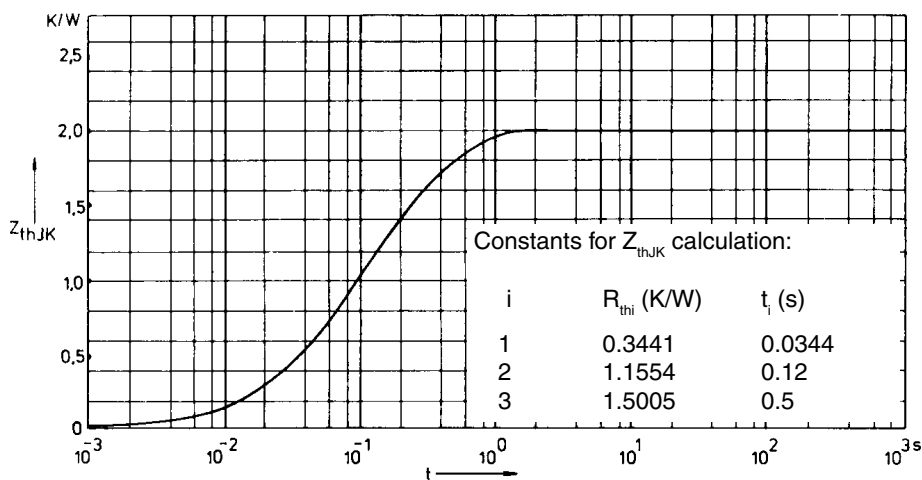


Fig. 7 Transient thermal impedance junction to heatsink per chip

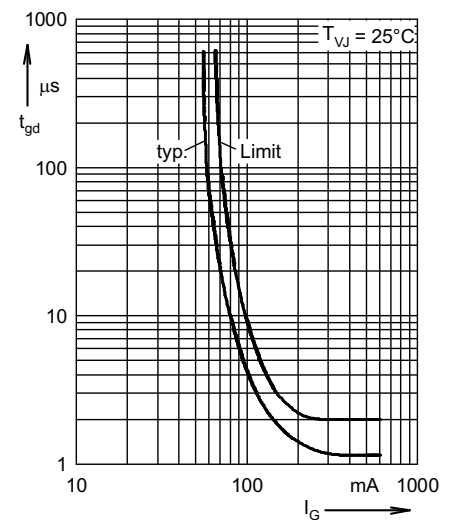


Fig. 7 Gate controlled delay time